



ES2AW THRU ES2JW

Reverse Voltage - 50 to 600 Volts Forward Current - 2.0 Ampere

SURFACE MOUNT GENERAL PURPOSE SILICON RECTIFIER

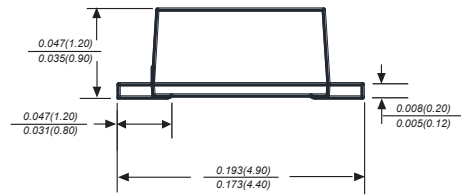
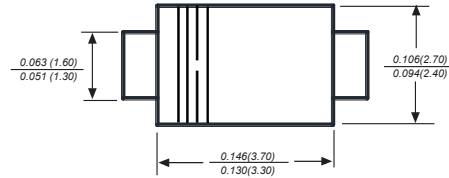
Features

- ◆ Glass passivated device
- ◆ Ideal for surface mounted applications
- ◆ Low reverse leakage
- ◆ Metallurgically bonded construction
- ◆ High temperature soldering guaranteed:
250°C/10 seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

Mechanical Data

Case: JEDEC UOD-123FL molded plastic body
 Terminals: Solderable per MIL-STD-750, Method 2026A
 Polarity: Polarity symbol marking on body
 Mounting Position: Any
 Weight: 0.0067 ounce, 0.02 grams

SOD-123FL



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	ES2AW	ES2BW	ES2CW	ES2DW	ES2EW	ES2GW	ES2JW	UNITS
		MDD 2E1	MDD 2E2	MDD 2E3	MDD 2E4	MDD 2E5	MDD 2E6	MDD 2E8	
Marking Code									
Maximum repetitive peak reverse voltage	V _{RMM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum average forward rectified current at Ta=65°C	I <sub(av)< sub=""></sub(av)<>	2.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	50							A
Maximum instantaneous forward voltage at 2.0A	V _F	0.95			1.25		1.7		V
Maximum DC reverse current TA=25°C at rated DC blocking voltage TA=125°C	I _R	5 100							μA
Typical junction capacitance (NOTE 1)	C _J	25							pF
Maximum Reverse Recovery Time (NOTE 2)	t _{rr}	35							ns
Typical thermal resistance (NOTE 3)	R _{θJA}	90							°C/W
Operating junction temperature range	T _J	-55 to +125							°C
Storage temperature range	T _{STG}	-55 to +150							°C

Note: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V D.C.
 2. P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.
 3. The typical data above is for reference only.



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Packing information



unit:mm

Item	Symbol	Tolerance	SOD-123FL
Carrier width	A	0.1	2.1
Carrier length	B	0.1	4.0
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	min	50.0
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W1	1.0	10.5

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-123FL	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	9.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	3.2	0.126
D	2	0.079
E	4.4	0.173

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